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From: Yingsheng Tung
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 972-917-5355

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Tsung et al.

Docket Number: TI-30243

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Serial No.: 09/921,324

Art Unit: 2823

Filed: 08/02/2001

Examiner: G. Fourson III

For: MASS PRODUCTION OF CROSS-SECTION TEM SAMPLES BY
FOCUSED ION BEAM DEPOSITION AND ANISOTROPIC ETCHING

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NAME OF INVENTOR(S) Tsung et al.	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/921,324	
TITLE OF INVENTION: Mass Production of Cross-Section TEM Samples by Focused Ion Beam Deposition...	
Filing Date: 08/02/2001	
TI FILE NO.: TI-30243	DEPOSIT ACCT. NO.: 20-0668
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265